PCN Number:	20181017001.0	PCN Date:	October 23,	2018	
Title: Datasheet for	r OPA838				
Customer Contact:	PCN Manager		Dept:	Quality Services	
Change Type:					
Assembly Site	Design		Wafei	r Bump Site	
Assembly Process		t	Wafei	r Bump Material	
Assembly Materials	s Part numb	er change	Wafei	r Bump Process	
Mechanical Specific	cation Test Site			r Fab Site	
Packing/Shipping/	Labeling	SS		r Fab Materials	
	Wafer Fab Process				
- I II I I I	Notification	n Details			
Description of Chang			1 1:6: 1:		
	orporated is announcing an			on.	
	(s) is being updated as sum istory provides further deta		٧.		
	istory provides further deta	3115.			
TEXAS INSTRUMENTS				000000	
INSTRUMENTS			SBOS867B - AUGUS	OPA838 ST 2017-REVISED OCTOBER 2018	
	2040) - 5		220000 D 3A0000	11000	
Changes from Revision A (F	February 2018) to Revision B			Page	
	n Current to < 1-μΑ Shutdown Cui				
 Changed value of common-mode and differential-mode input impedance in Electrical Characteristics: V_S = 5 V and Electrical Characteristics: V_S = 3 V tables					
 Changed value of power-down quiescent current in Electrical Characteristics: V_S = 5 V and Electrical Characteristics: V_S = 3 V tables					
	Overview section				
 Changed standby current from 5 μA to 1 μA in Power-Down Operation section. 					
	Changed common-mode input capacitance from 1.3 pF to 1 pF in Trade-Offs in Selecting The Feedback Resistor Value section				
adding the 1-pF device co	.25 V/V, adding the 1.3-pF device mmon-mode capacitance in Trade	-Offs in Selecting	The Feedback F	Resistor Value section 22	
	and 5 μ A to 1 μ A in last sentence of		The state of the s		
 Changed Power Supply R 	ecommendations and Thermal No	tes title to Power S	Supply Recomm	endations36	
The datachest number	will be abanaina				
The datasheet number Device Family	will be changing.	Change F	rom	Change To:	
Device railily					
OPA838		SBOS867	'A	SBOS867B	
These changes may be reviewed at the datasheet links provided.					
http://www.ti.com/product/OPA838					
Reason for Change:					
To accurately reflect device characteristics.					
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):					
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.					
Changes to product identification resulting from this PCN:					
None.					
Product Affected:			1		
OPA838IDBVR	OPA838IDBVT	OPA838IDCKR		DPA838IDCKT	
OPA838SIDCKR	OPA838SIDCKT				
For questions regarding this notice, o-mails can be cont to the regional contacts shown below					

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com

Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com